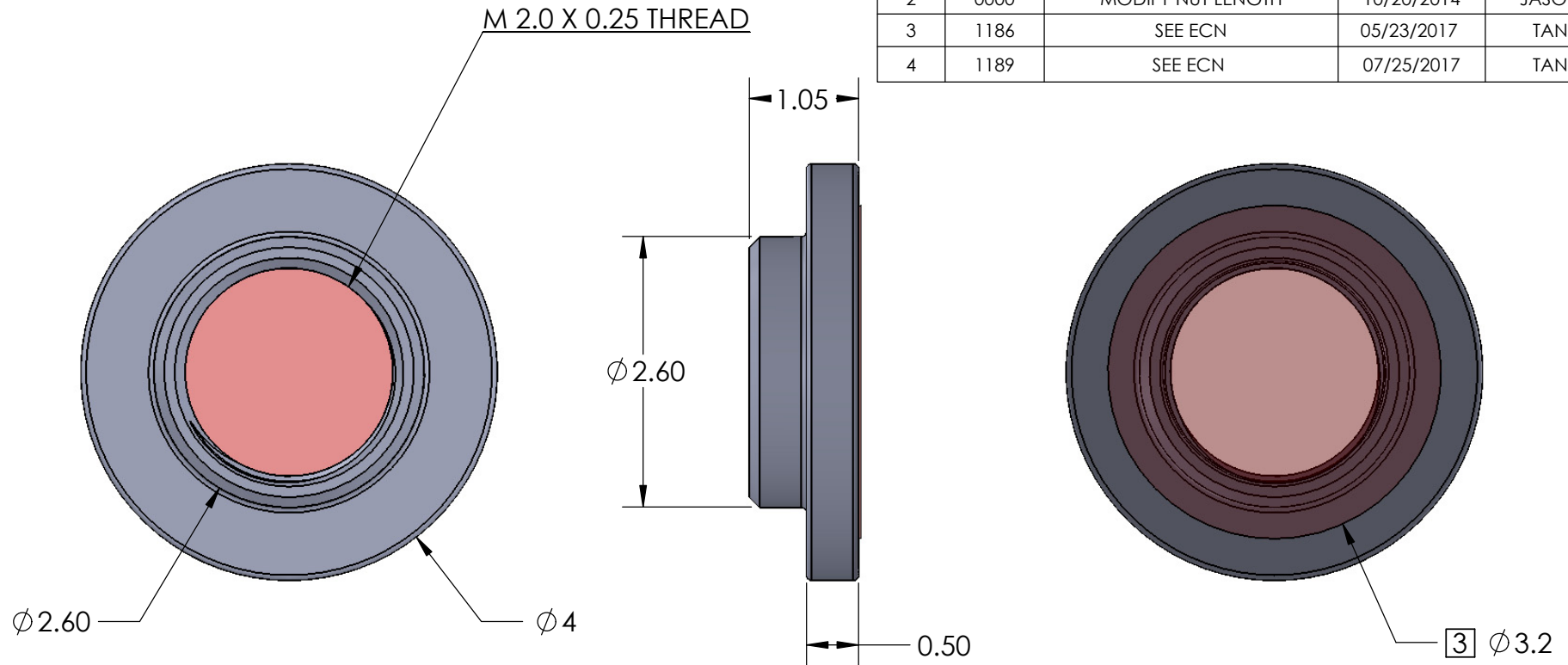


REVISIONS				
REV.	ECN #	DESCRIPTION	DATE	DRAWN BY:
1	0000	NEW RELEASE	09/23/2014	JASON
2	0000	MODIFY NUT LENGTH	10/20/2014	JASON
3	1186	SEE ECN	05/23/2017	TAN
4	1189	SEE ECN	07/25/2017	TAN



NOTES:

- MATERIAL: PHOSPHOR BRONZE, UNS C54400 H04 TEMPER (UTS 450MPa MIN) OR EQUIVALENT.
- FINISH: 120u" MIN BRIGHT TIN OVER 40u" MIN NICKEL UNDER PLATE.
- 3 HI-TEMP POLYIMIDE TAPE, 260 °C [500 °F] MINIMUM, TOTAL THICKNESS .025-.076 MM [.001-.003 IN] ADHESION TO STEEL 27 N/100 MM [25 OZ/IN] MINIMUM, PER ASTM D3330 OR EQUIV.
- PART TO BE FREE OF BURRS AND SHARP EDGES.

DIMENSIONS ARE IN mm TOLERANCES (unless otherwise specified): ANGULAR: ± 2 degree LINEAR: .X ±0.15 .XX ±0.10 .XXX ±0.05		NAME	DATE	
	DRAWN	Jason Wu	09/23/2014	
	CHECKED	Gary Hsieh	09/23/2014	
	Appr	Gary Hsieh	09/23/2014	
	Release level	PRODUCTION		Title: M2.0 X 1.05 NUT [FOR 0.6-1.0 mm THK PCB]
MATERIAL	DO NOT SCALE DRAWING	projection		DWG. NO. B01-000633
FINISH			SIZE A	REV. 4
		SCALE:5:1	WEIGHT:	SHEET 1 OF 1